

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JOSEPH ANTHONY HOLUNG	08/05/2020
BOUZIANE YEBKA	08/05/2020
PHILIP JOHN JAKES	08/05/2020
TIN-LUP WONG	08/06/2020
JOSEPH DAVID PLUNKETT	08/06/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	LENOVO (SINGAPORE) PTE. LTD.
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<b>Internal Address:</b>	#02-01, NEW TECH PARK
<b>City:</b>	SINGAPORE
<b>State/Country:</b>	SINGAPORE
<b>Postal Code:</b>	556741
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	16945433
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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<b>ATTORNEY DOCKET NUMBER:</b>	RPS920200045-US-NP
<b>NAME OF SUBMITTER:</b>	BRIAN J. PANGRLE
<b>SIGNATURE:</b>	/Brian J. Pangrle/
<b>DATE SIGNED:</b>	07/28/2021

**Total Attachments: 2**

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## *Assignment*

Whereas, we

INVENTOR (1) Joseph Anthony Holung  
AND CITY of 8608 Purnell Ridge Road, Wake Forest, North Carolina 27587

INVENTOR (2) Bouziane Yebka  
AND CITY of 3014 Wolfs Bane Drive, Apex, North Carolina 27539

INVENTOR (3) Philip John Jakes  
AND CITY of 805 Watts Street, Durham, North Carolina 27701

INVENTOR (4) Tin-Lup Wong  
AND CITY of 207 Tremont Circle, Chapel Hill, North Carolina 27516

INVENTOR (5) Joseph David Plunkett  
AND CITY of 4801 Bartwood Drive, Raleigh, North Carolina 27613

have invented certain improvements in

TITLE SYSTEM HINGE ASSEMBLY

and have executed, respectively, a United States patent application therefor having Serial No. 16/945,433, filed on 31 July 2020.

Whereas, Lenovo (Singapore) Pte. Ltd., a corporation of Singapore, having a place of business at 151, Lorong Chuan, #02-01, New Tech Park, Singapore 556741, (hereinafter called Lenovo), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to Lenovo, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said applications to Lenovo, its successors and assigns; and we hereby agree that Lenovo may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by Lenovo.

Signed and sealed

CITY AND (1) at \_\_\_ Wake Forest \_\_\_  
DATE on \_\_\_ 08/05/2020 \_\_\_, 2020 /Joseph Anthony Holung/  
Joseph Anthony Holung

SIGNATURE  
INVENTOR

CITY AND  
DATE

(2) at Morrisville  
on 05/08/, 2020

/Bouziane Yebka/  
Bouziane Yebka

SIGNATURE  
INVENTOR

CITY AND  
DATE

(3) at Durham, NC  
on August 5, 2020

/Philip John Jakes/  
Philip John Jakes

SIGNATURE  
INVENTOR

CITY AND  
DATE

(4) at Chapel Hill, NC  
on August 6, 2020

/Tin-Lup Wong/  
Tin-Lup Wong

SIGNATURE  
INVENTOR

CITY AND  
DATE

(5) at Raleigh, NC  
on August 6, 2020

/Joseph David Plunkett/  
Joseph David Plunkett

SIGNATURE  
INVENTOR